

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
AN YANG	03/13/2020
LVHAI HU	03/13/2020
YUN LIU	03/13/2020
SUN KYU PAK	03/13/2020
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<b>Internal Address:</b>	CHINA (SHANGHAI) PILOT FREE TRADE ZONE
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<b>State/Country:</b>	CHINA
<b>Name:</b>	TE CONNECTIVITY CORPORATION
<b>Street Address:</b>	1050 WESTLAKES DRIVE
<b>City:</b>	BERWYN
<b>State/Country:</b>	PENNSYLVANIA
<b>Postal Code:</b>	19312
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	16808937
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(610)889-3696
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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<b>ATTORNEY DOCKET NUMBER:</b>	21334-2977

<b>NAME OF SUBMITTER:</b>	SALVATORE ANASTASI
<b>SIGNATURE:</b>	/Salvatore Anastasi/
<b>DATE SIGNED:</b>	10/08/2020
<b>Total Attachments: 2</b> source=Declaration#page1.tif source=Declaration#page2.tif	

**COMBINED DECLARATION AND ASSIGNMENT**

As a below named and signing inventor, I hereby declare that:

this declaration is directed to inventions and improvements disclosed in:

\_\_\_ the attached application, or.

X United States application or PCT international application number 16/808,937  
filed on March 4, 2020, entitled Metal Foil Flaring Apparatus ("the APPLICATION");

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

**Tyco Electronics (Shanghai) Co. Ltd. and TE Connectivity Corporation** ("ASSIGNEE"), corporations organized and existing under and by virtue of the laws of China and Switzerland, having their principal places of business at Sections F, G and H, Level 1, Building 15, No. 999 Yinglun Rd., China (Shanghai) Pilot Free Trade Zone, Shanghai, China and 1050 Westlakes Drive, Berwyn, Pennsylvania 19312,

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer, and set over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the United States of America, its territories and possessions, but also for, to and in all other countries, including all priority rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof; and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment.

Legal Name	Signature	Date

An Yang	Yang An	2020/3/13
Lvhai Hu	lvhai	13/03/2020
Yun Liu	Liyun	2020/3/13
Sun Kyu Pak	Sun Kyu Pak	03/13/2020